Electronic Pat	ent App	lication Fee	Transmi	ittal			
Application Number:	107	10719020					
Filing Date:	24-	24-Nov-2003					
Title of Invention:		METHOD FOR PREPARING A CIRCUIT BOARD MATERIAL HAVING A CONDUCTIVE BASE AND A RESISTANCE LAYER					
First Named Inventor/Applicant Name:	Aki	Akira Matsuda					
Filer:	Ste	Stephen G. Adrian/Anita Plummer					
Attorney Docket Number:	032	032130					
Filed as Large Entity	•						
Utility under 35 USC 111(a) Filing Fees							
Description	Description		Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:					1		
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Utility Appl issue fee		1501	1	1510	1510		

Publ. Fee- early, voluntary, or normal

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
	Total in USD (\$)			1810